

Low Loss DuoPack : IGBT in TRENCHSTOP<sup>™</sup> and Fieldstop technology with soft, fast recovery anti-parallel Emitter Controlled HE diode



#### Features:

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- Very low V<sub>CE(sat)</sub> 1.5V (typ.)
- Maximum Junction Temperature 175°C
  - Short circuit withstand time 5µs
- Designed for :
  - Frequency Converters
  - Uninterrupted Power Supply
- TRENCHSTOP™ and Fieldstop technology for 600V applications offers :
  - very tight parameter distribution
  - high ruggedness, temperature stable behavior
  - very high switching speed
  - Iow V<sub>CE(sat)</sub>
- Positive temperature coefficient in V<sub>CE(sat)</sub>
- Low EMI
- Low Gate Charge
- Very soft, fast recovery anti-parallel Emitter Controlled HE diode
- Qualified according to JEDEC<sup>1</sup> for target applications
- Pb-free lead plating; RoHS compliant
- Complete product spectrum and PSpice Models : <u>http://www.infineon.com/igbt/</u>

Туре	V <sub>CE</sub>	I <sub>C</sub>	V <sub>CE(sat),Tj=25℃</sub>	<b>T</b> j,max	Marking	Package
IKW20N60T	600V	20A	1.5V	175°C	K20T60	PG-TO247-3

#### **Maximum Ratings**

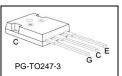
Parameter	Symbol	Value	Unit	
Collector-emitter voltage, $T_j \ge 25^{\circ}C$	V <sub>CE</sub>	600	V	
DC collector current, limited by $T_{jmax}$ $T_{C} = 25^{\circ}C$		41		
$T_{\rm C} = 100^{\circ}{\rm C}$	I <sub>C</sub>	28		
Pulsed collector current, $t_p$ limited by $T_{jmax}$	I <sub>Cpuls</sub>	60	•	
Turn off safe operating area, $V_{CE} = 600V$ , $T_j = 175^{\circ}C$ , $t_p = 1\mu s$	-	60	A	
Diode forward current, limited by $T_{jmax}$ $T_{C} = 25^{\circ}C$	,	41		
$T_{\rm C} = 100^{\circ}{\rm C}$	/ <sub>F</sub>	28		
Diode pulsed current, $t_p$ limited by $T_{jmax}$	I <sub>Fpuls</sub>	60		
Gate-emitter voltage	V <sub>GE</sub>	±20	V	
Short circuit withstand time <sup>2)</sup>	4	5		
$V_{\text{GE}}$ = 15V, $V_{\text{CC}} \le 400$ V, $T_j \le 150^{\circ}$ C	t <sub>sc</sub>	5	μs	
Power dissipation $T_{\rm C} = 25^{\circ}{\rm C}$	P <sub>tot</sub>	166	W	
Operating junction temperature	Tj	-40+175		
Storage temperature	T <sub>stg</sub>	-55+150	°C	
Soldering temperature, 1.6mm (0.063 in.) from case for 10s	-	260		

<sup>1</sup> J-STD-020 and JESD-022

<sup>2)</sup> Allowed number of short circuits: <1000; time between short circuits: >1s.

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#### **Thermal Resistance**

Parameter	Symbol	Conditions	Max. Value	Unit
Characteristic				1
IGBT thermal resistance,	P		0.0	
junction – case	R <sub>thJC</sub>		0.9	
Diode thermal resistance,	D		4.5	K/W
junction – case	$R_{thJCD}$		1.5	
Thermal resistance,	D		40	
junction – ambient	R <sub>thJA</sub>		40	

### **Electrical Characteristic,** at $T_j$ = 25 °C, unless otherwise specified

Devementer	Cumb ol	Conditions	Value			11
Parameter	Symbol	Conditions	min.	Тур.	max.	Unit
Static Characteristic						
Collector-emitter breakdown voltage	$V_{(BR)CES}$	$V_{GE}=0V, I_{C}=0.2mA$	600	-	-	
Collector-emitter saturation voltage		$V_{\rm GE} = 15 V, I_{\rm C} = 20 A$				
	V <sub>CE(sat)</sub>	<i>T</i> <sub>j</sub> =25°C	-	1.5	2.05	
		<i>T</i> <sub>j</sub> =175°C	-	1.9	-	V
Diode forward voltage		$V_{\rm GE} = 0V, I_{\rm F} = 20A$				-  V
	V <sub>F</sub>	<i>T</i> <sub>j</sub> =25°C	-	1.65	2.05	
		<i>T</i> <sub>j</sub> =175°C	-	1.6	-	
Gate-emitter threshold voltage	V <sub>GE(th)</sub>	$I_{\rm C} = 290 \mu {\rm A}, V_{\rm CE} = V_{\rm GE}$	4.1	4.9	5.7	
Zero gate voltage collector current		V <sub>CE</sub> =600V, V <sub>GE</sub> =0V				
	I <sub>CES</sub>	<i>T</i> <sub>j</sub> =25°C	-	-	40	μA
		<i>T</i> <sub>j</sub> =175°C	-	-	1500	
Gate-emitter leakage current	I <sub>GES</sub>	$V_{CE}=0V, V_{GE}=20V$	-	-	100	nA
Transconductance	$g_{ m fs}$	$V_{\rm CE} = 20 V, I_{\rm C} = 20 A$	-	11	-	S
Integrated gate resistor	R <sub>Gint</sub>			-		Ω

### **Dynamic Characteristic**

-						
Input capacitance	Ciss	$V_{CE}=25V$ ,	-	1100	-	
Output capacitance	Coss	$V_{GE}=0V$ ,	-	71	-	pF
Reverse transfer capacitance	Crss	f=1MHz	-	32	-	
Gate charge	Q <sub>Gate</sub>	V <sub>CC</sub> =480V, <i>I</i> <sub>C</sub> =20A V <sub>GE</sub> =15V	-	120	-	nC
Internal emitter inductance measured 5mm (0.197 in.) from case	L <sub>E</sub>	PG-TO247-3	-	13	-	nH
Short circuit collector current <sup>1)</sup>	I <sub>C(SC)</sub>	$V_{GE}$ =15V, $t_{SC}$ ≤5µs $V_{CC}$ = 400V, $T_j$ ≤ 150°C	-	183.3	-	А

 $^{1)}$  Allowed number of short circuits: <1000; time between short circuits: >1s.



### Switching Characteristic, Inductive Load, at $T_j=25 \text{ °C}$

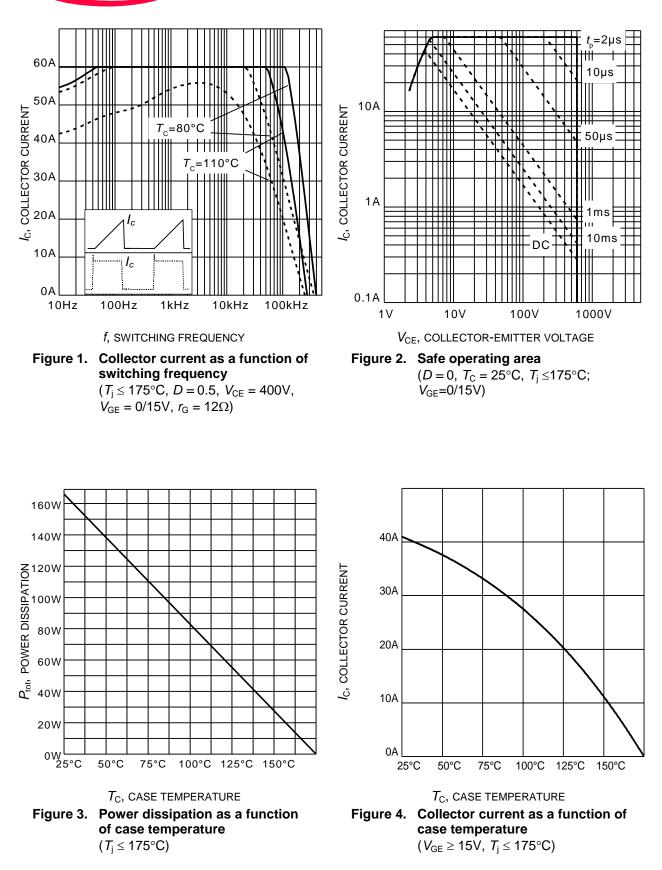
Poromotor	Symbol	Conditions	Value			l Imit
Parameter	Symbol	Conditions	min.	Тур.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t <sub>d(on)</sub>	<i>T</i> <sub>j</sub> =25°C,	-	18	-	- ns
Rise time	t <sub>r</sub>	$V_{\rm CC} = 400  \text{V}, I_{\rm C} = 20  \text{A},$ $V_{\rm GE} = 0/15  \text{V}, r_{\rm G} = 12  \Omega,$	-	14	-	
Turn-off delay time	$t_{d(off)}$	$L_{\sigma} = 131 \text{ nH}, C_{\sigma} = 31 \text{ pF}$	-	199	-	
Fall time	t <sub>f</sub>	]	-	42	-	
Turn-on energy	Eon	$L_{\sigma}$ , $C_{\sigma}$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	0.31	-	mJ
Turn-off energy	E <sub>off</sub>		-	0.46	-	
Total switching energy	Ets		-	0.77	-	
Anti-Parallel Diode Characteristic		·				
Diode reverse recovery time	t <sub>rr</sub>	<i>T</i> <sub>j</sub> =25°C,	-	41	-	ns
Diode reverse recovery charge	Q <sub>rr</sub>	V <sub>R</sub> =400V, <i>I</i> <sub>F</sub> =20A,	-	0.31	-	μC
Diode peak reverse recovery current	<i>I</i> <sub>rrm</sub>	di <sub>F</sub> /dt=880A/µs	-	13.3	-	А
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	di <sub>rr</sub> /dt		-	711	-	A/µs

### Switching Characteristic, Inductive Load, at T<sub>j</sub>=175 °C

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Parameter	Symbol	Conditions	min.	Тур.	max.	Unit
IGBT Characteristic						
Turn-on delay time	t <sub>d(on)</sub>	<i>T</i> <sub>j</sub> =175°C,	-	18	-	- ns
Rise time	t <sub>r</sub>	$V_{\rm CC} = 400  \text{V}, I_{\rm C} = 20  \text{A},$ $V_{\rm GE} = 0/15  \text{V}, r_{\rm G} = 12  \Omega,$	-	18	-	
Turn-off delay time	t <sub>d(off)</sub>	$L_{\sigma}$ =131nH, $C_{\sigma}$ =31pF	-	223	-	
Fall time	<i>t</i> <sub>f</sub>		-	76	-	
Turn-on energy	Eon	$L_{\sigma}$ , $C_{\sigma}$ from Fig. E Energy losses include "tail" and diode reverse recovery.	-	0.51	-	mJ
Turn-off energy	E <sub>off</sub>		-	0.64	-	
Total switching energy	Ets		-	1.15	-	
Anti-Parallel Diode Characteristic						
Diode reverse recovery time	t <sub>rr</sub>	<i>T</i> <sub>j</sub> =175°C	-	176	-	ns
Diode reverse recovery charge	Q <sub>rr</sub>	$V_{\rm R}$ =400V, $I_{\rm F}$ =20A,	-	1.46	-	μC
Diode peak reverse recovery current	l <sub>rrm</sub>	di <sub>F</sub> /dt=880A/µs	-	18.9	-	А
Diode peak rate of fall of reverse recovery current during $t_{\rm b}$	di <sub>rr</sub> /dt		-	467	-	A/μs

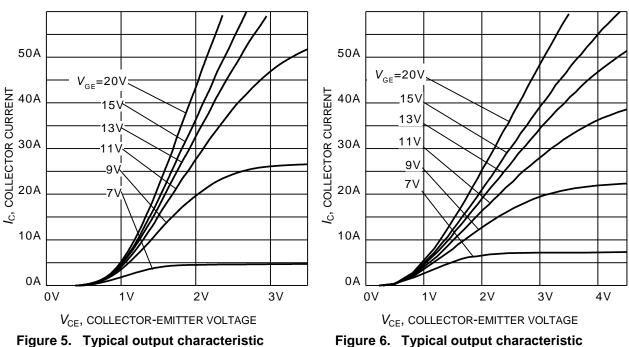


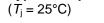
### **TRENCHSTOP™** Series

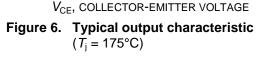




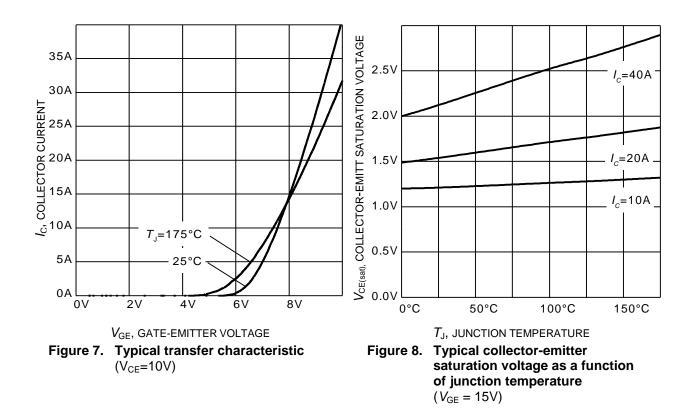
## TRENCHSTOP<sup>™</sup> Series





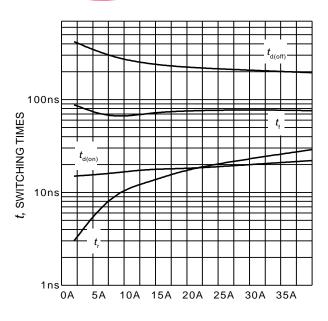


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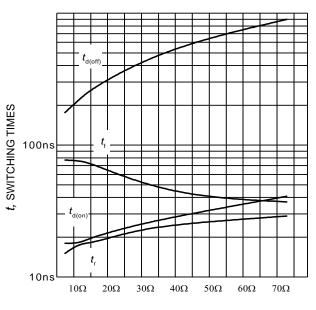


## TRENCHSTOP™ Series



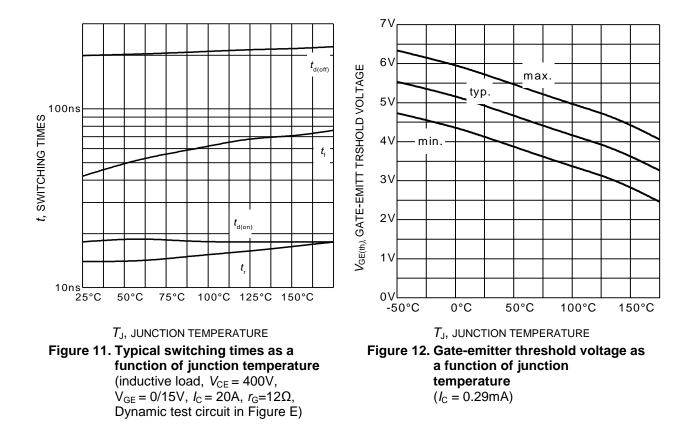
 $I_C$ , COLLECTOR CURRENT

Figure 9. Typical switching times as a function of collector current (inductive load,  $T_J=175^{\circ}C$ ,  $V_{CE} = 400V$ ,  $V_{GE} = 0/15V$ ,  $r_G = 12\Omega$ , Dynamic test circuit in Figure E)



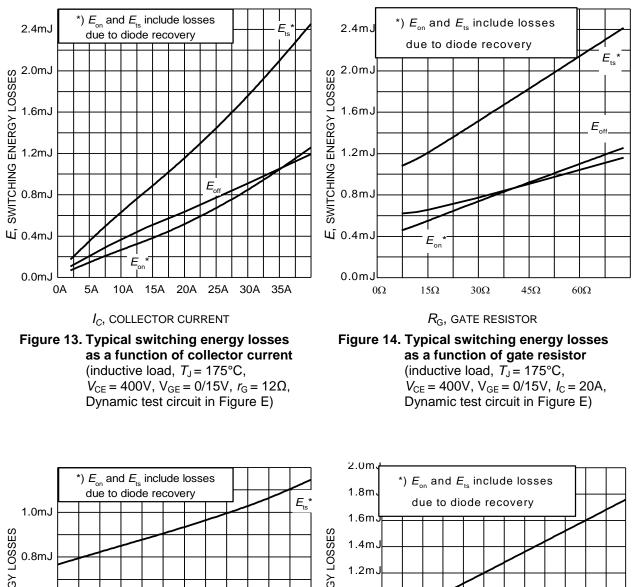
 $R_{\rm G}$ , gate resistor

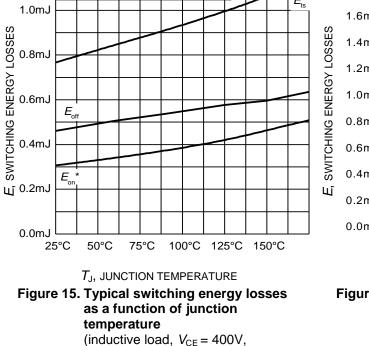
Figure 10. Typical switching times as a function of gate resistor (inductive load,  $T_J = 175^{\circ}$ C,  $V_{CE} = 400$ V,  $V_{GE} = 0/15$ V,  $I_C = 20$ A, Dynamic test circuit in Figure E)





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 $V_{GE} = 0/15V, I_C = 20A, r_G = 12\Omega,$ 

Dynamic test circuit in Figure E)

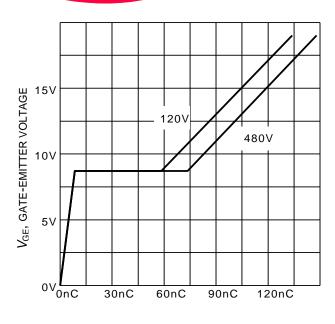
1.0mJ  $E_{ts}^{*}$ 0.8mJ  $E_{off}^{*}$ 0.6mJ  $E_{on}^{*}$ 0.2mJ 0.0mJ  $E_{on}^{*}$ 0.0mJ 0.0mJ

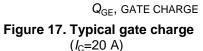
 $V_{CE}$ , COLLECTOR-EMITTER VOLTAGE Figure 16. Typical switching energy losses as a function of collector emitter voltage (inductive load,  $T_{J}$  = 175°C,

 $V_{GE} = 0/15V$ ,  $I_C = 20A$ ,  $r_G = 12\Omega$ , Dynamic test circuit in Figure E)



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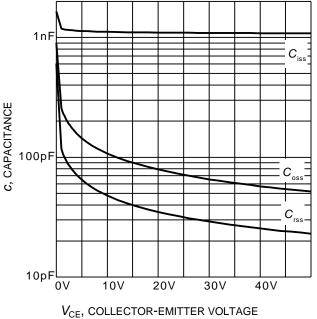
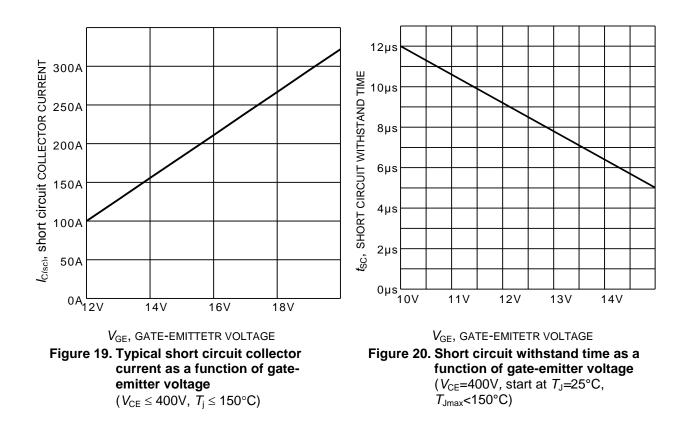


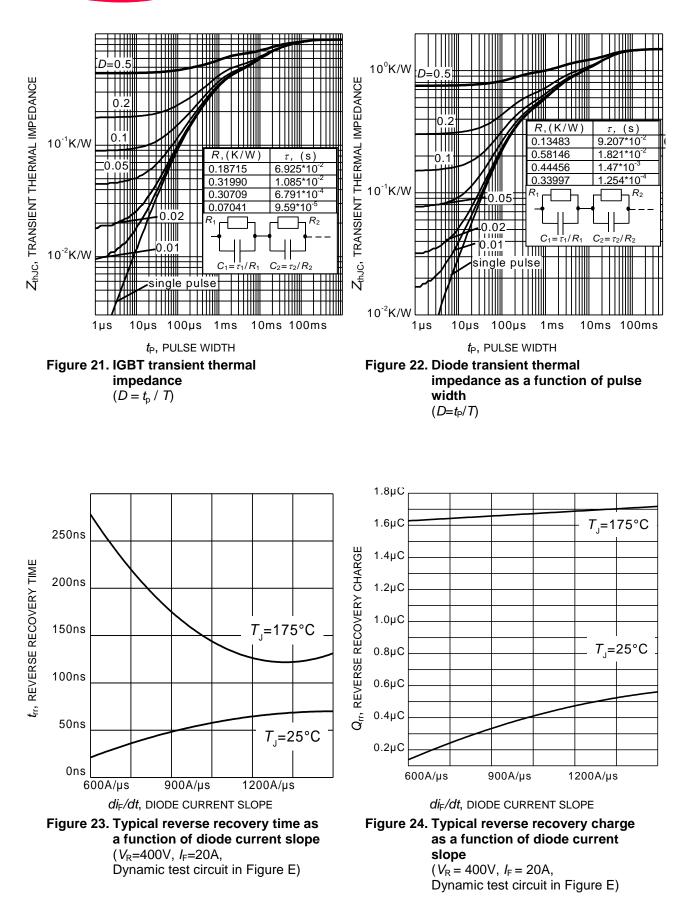
Figure 18. Typical capacitance as a function of collector-emitter voltage  $(V_{GE}=0V, f = 1 \text{ MHz})$ 





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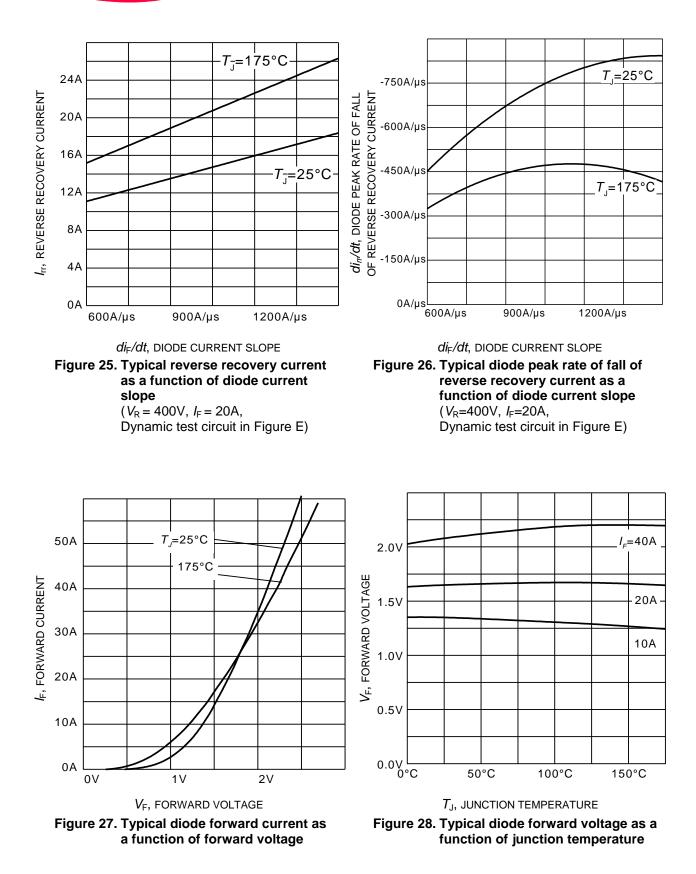
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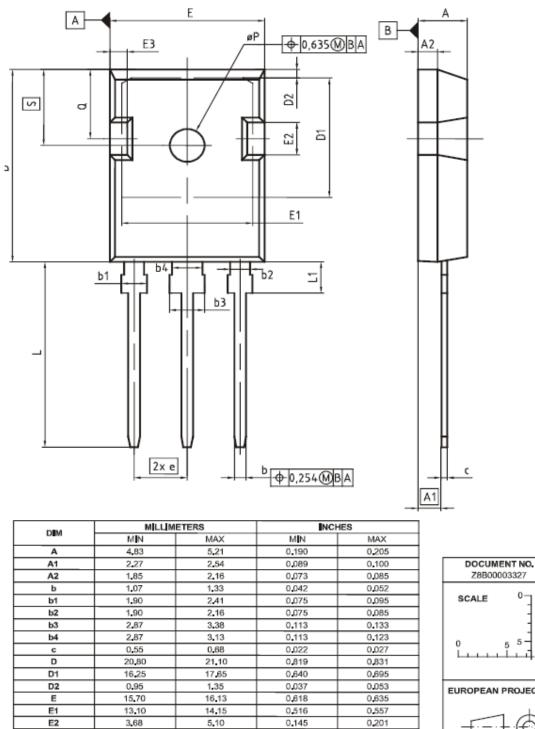
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TRENCHSTOP<sup>™</sup> Series

PG-TO247-3



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19,80

4.10

3,50

5,49

6.04

0.039

0.780

0,161

0.138

0,216

0,238

2,60

20.32

4.47

3,70

6,00

6,30

5.44 (BSC)

3

0.102

0,800

0.176

0.146

0,236

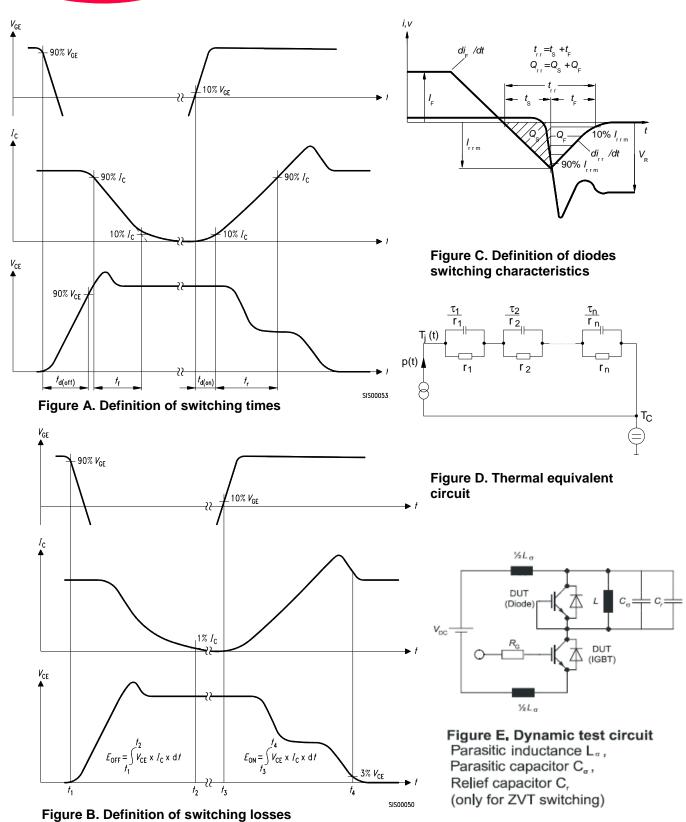
0,248

0.214 (BSC)

3



TRENCHSTOP<sup>™</sup> Series



IFAG IPC TD VLS



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